

## PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
SUNG HYUN LEE	08/25/2017
JUNG HUN LEE	08/25/2017
DONG WON SHIN	08/25/2017
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<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>Postal Code:</b>	31040
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16933435
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	CHM-0025-DA1-SS
<b>NAME OF SUBMITTER:</b>	JAE Y. PARK
<b>SIGNATURE:</b>	/JAE Y. PARK/
<b>DATE SIGNED:</b>	07/20/2020
This document serves as an Oath/Declaration (37 CFR 1.63).	
<b>Total Attachments: 3</b>	
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source=Decl_Assmt_CHM0025DA1#page2.tif	



COMBINED DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION  
USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

<p>Title of Invention</p>	<p>CONTACTLESS DRIVING MODULE AND TRANSFER APPARATUS HAVING THE SAME</p>
<p>As the below named inventor, I hereby declare that:</p> <p>This declaration is directed to:</p> <p><input checked="" type="checkbox"/> The attached application,</p> <p><input type="checkbox"/> United States application number _____ filed on _____, or</p> <p><input type="checkbox"/> PCT international application number _____ filed on _____.</p> <p>The above-identified application was made or authorized to be made by me.</p> <p>I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.</p> <p>I have reviewed and understand the contents of the above-identified application, including the claims. I am aware of the duty to disclose information which is material to patentability as defined in 37 CFR 1.56.</p> <p>I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.</p> <p>WHEREAS, <u>SEMES CO., LTD.</u> of <u>77, 4sandan 5-gil, Jiksan-eup, Seobuk-gu, Cheonan-si, Chungcheongnam-do, 31040 Republic of Korea</u>, its heirs, successors, legal representatives and assigns (hereinafter referred to as "ASSIGNEE") is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefore in the United States of America and in any foreign countries.</p> <p>NOW, THEREFORE, to all whom it may concern, be it known that, for good and valuable consideration paid to the undersigned, the receipt of which is hereby acknowledged, I have sold, assigned and transferred, and by these presents does sell, assign and transfer unto the Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefore in the United States of America, its territories, dependencies and possessions, and in any and all foreign countries;</p> <p>and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or terms for which the same may be granted.</p>	

KILE PARK REED & HOUTTEMAN PLLC  
WASHINGTON DC USA

United States Patent and Trademark Office

I agree to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

I agree to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

I agree to execute all papers and documents and to perform any act which may be necessary in connection with claims and provisions of the International Convention for the Protection of Industrial Property or similar agreements.

I agree to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by me if this Assignment and sale had not been made.

I hereby authorize and request the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, and hereby covenant that I have the full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

I declare that all statements made in the above assignment of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C.1001 and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

LEGAL NAME OF INVENTOR

Inventor: Sung Hyun LEE  
*name*

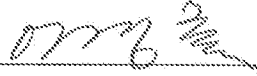
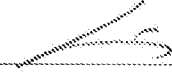
Citizenship: Republic of Korea  
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Date: Aug. 25, 2017

Signature: Sung Hyun Lee

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COMBINED DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION  
USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

LEGAL NAME OF INVENTOR	
Inventor: <u>Jung Hun LEE</u> <i>name</i>	Citizenship: <u>Republic of Korea</u> <i>country</i>
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